

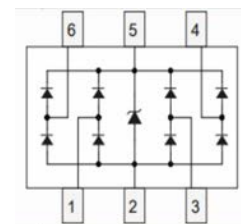


Discription

The H824001 is a 5-channel ultra low capacitance rail clamp ESD protection diodes array. Each channel consists of a pair of ESD diodes that steer positive or negative ESD current to either the positive or negative rail. A zener diode is integrated in to the array between the positive and negative supply rails. In the typical applications, the negative rail pin (assigned as GND) is connected with system ground. The Positive ESD current is steered to the ground through an ESD diode and Zener diode and the positive ESD voltage is clamped to the zener voltage.



SOT-23-6L



Circuit Diagram

Features

- ★ 5 channels of ESD protection
- ★ Provides ESD protection to IEC61000-4-2 level 4
 - ±27kV air discharge
 - ±15kV contact discharge
- ★ Channel I/O to GND capacitance: 0.4pF(Max)
- ★ Channel I/O to I/O capacitance: 0.8pF(Max)
- ★ Low clamping voltage
- ★ Low operating voltage
- ★ Improved zener structure
- ★ Optimized package for easy high speed data lines PCB layout
- ★ RoHS compliant.

Ordering information

Product ID	Pack	Qty(PCS)
H824001	SOT-23-6L	3000

Absolute Ratings(Tamb = 25°C)

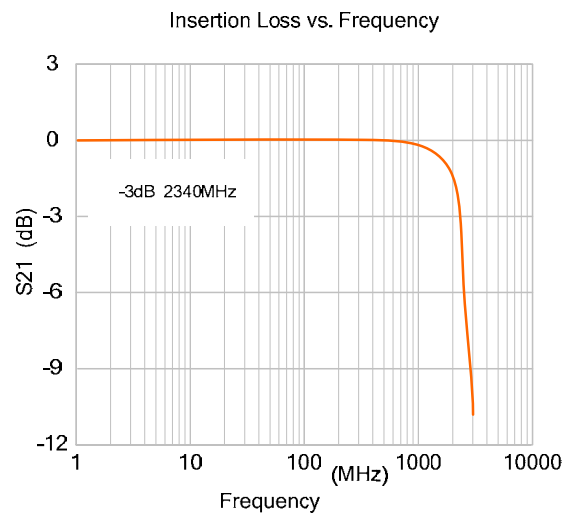
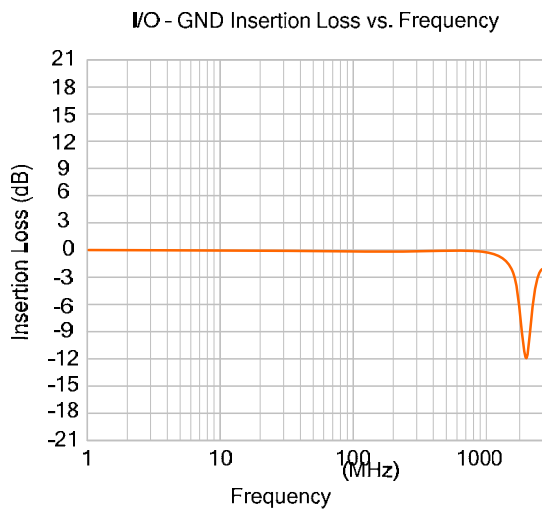
Characteristics	Symbol	Ratings	Unit
Peak Pulse Power(8/20μs)	P _{PP}	55	W
Peak Pulse Current(8/20μs)	I _{PP}	4	A
ESD per IEC 61000-4-2(Air)	V _{ESD1}	±20kV	kV
ESD per IEC 61000-4-2(Contact)	V _{ESD2}	±15kV	kV
Operating Temperature Range	T _{opr}	-55 ~ +125	°C
Storage Temperature Range	T _{stg}	-55 ~ +150	°C

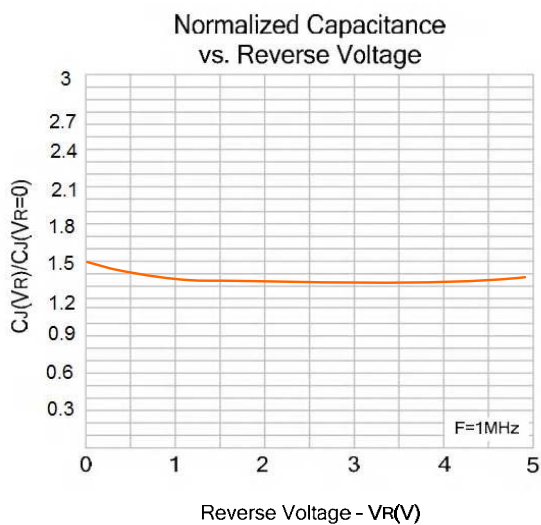
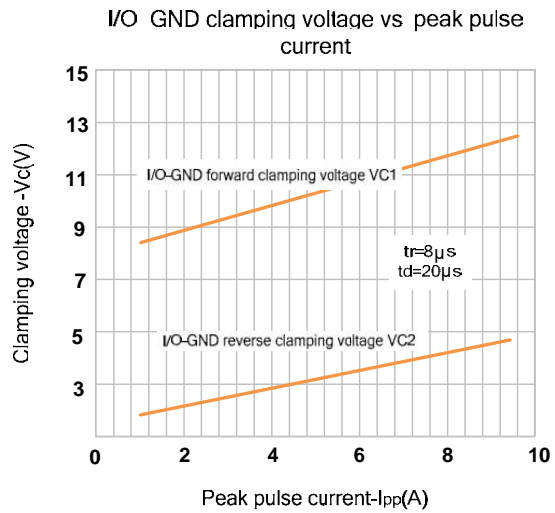
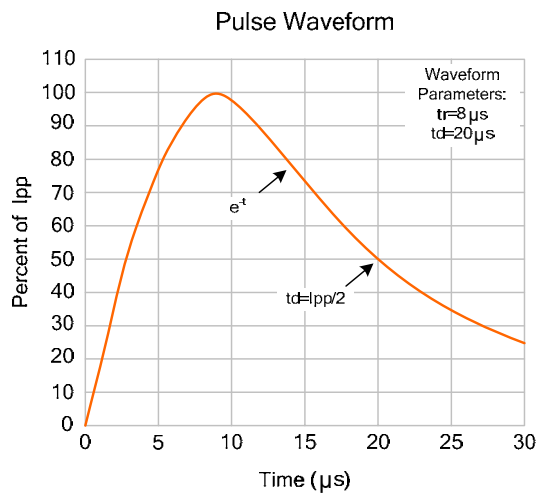
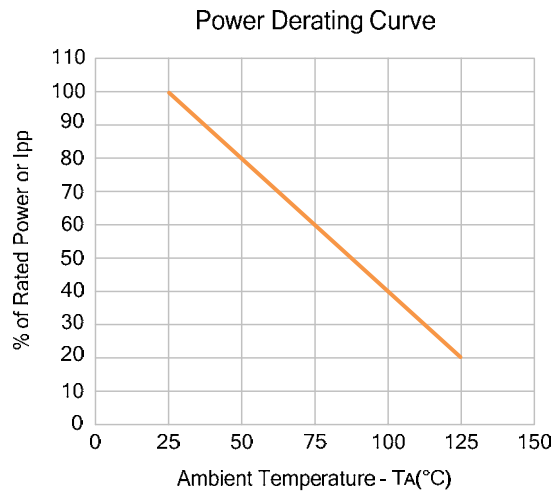
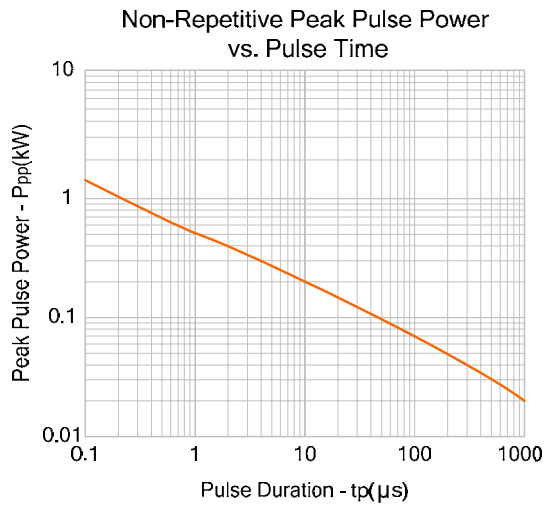


Electrical Characteristics (T_{amb}=25°C)

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Reverse Working Voltage	V _{RWM}	Any I/O pin to GND			5	V
Reverse Breakdown Voltage	V _{BR}	I _t =1mA; Any I/O pin to GND	6			V
Reverse Leakage Current	I _R	V _{RWM} =5V, T=25°C; Any I/O pin to GND			1	μA
Positive Clamping Voltage	V _{C1}	I _{PP} =4A, t _P =8/20μs; Positive pulse; Any I/O pin to GND		8.5	12.0	V
Negative Clamping Voltage	V _{C2}	I _{PP} =4A, t _P =8/20μs; Negative pulse; Any I/O pin to GND		1.8		V
Junction Capacitance Between Channel	C _{J1}	V _R =0V, f=1MHz; Between I/O pins		0.3	0.4	pF
Junction Capacitance Between I/O And GND	C _{J2}	V _R =0V, f=1MHz; Any I/O pin to GND		0.6	0.8	pF

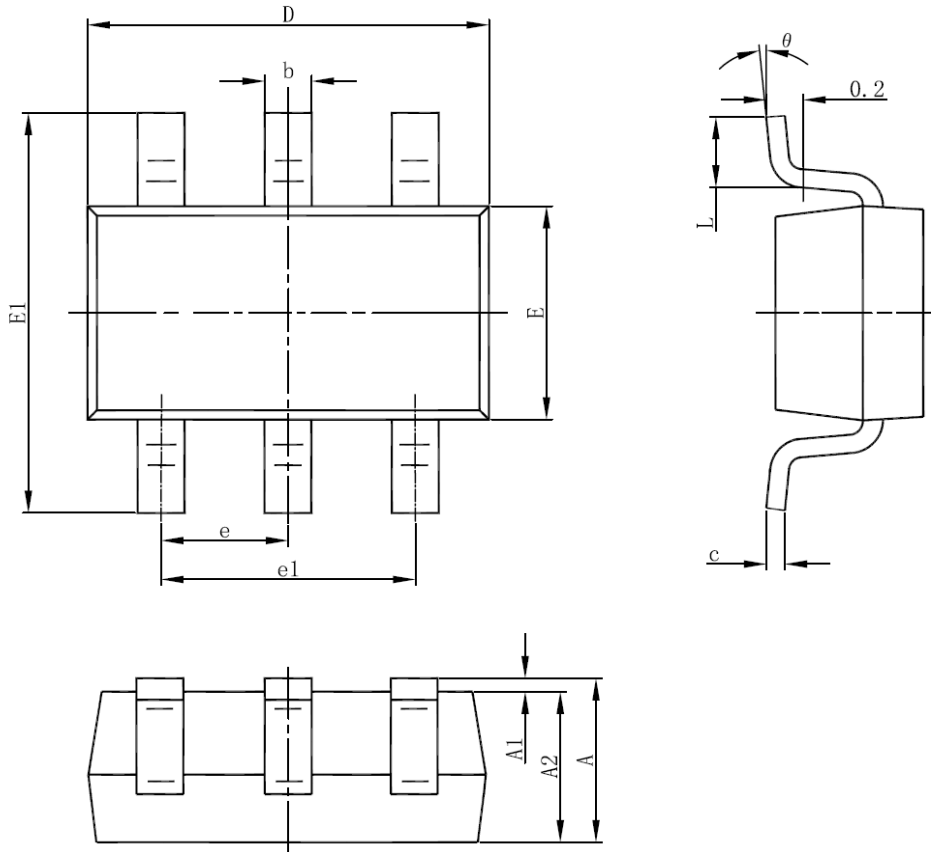
Typical Characteristics







SOT-23-6L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°



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